## MC14076B

## 4-Bit D-Type Register with Three-State Outputs

The MC14076B 4-Bit Register consists of four D-type flip-flops operating synchronously from a common clock. OR gated output-disable inputs force the outputs into a high-impedance state for use in bus organized systems. OR gated data-disable inputs cause the Q outputs to be fed back to the D inputs of the flip-flops. Thus they are inhibited from changing state while the clocking process remains undisturbed. An asynchronous master root is provided to clear all four flip-flops simultaneously independent of the clock or disable inputs.

## Features

- Three-State Outputs with Gated Control Lines
- Fully Independent Clock Allows Unrestricted Operation for the Two Modes: Parallel Load and Do Nothing
- Asynchronous Master Reset
- Four Bus Buffer Registers
- Supply Voltage Range = 3.0 Vdc to 18 Vdc
- Capable of Driving Two Low-Power TTL Loads or One Low-Power Schottky TTL Load Over the Rated Temperature Range
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are $\mathrm{Pb}-$ Free and are RoHS Compliant

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SOIC-16
D SUFFIX
CASE 751B

## MARKING DIAGRAM



A $\quad=$ Assembly Location
WL, L = Wafer Lot
YY, Y = Year
WW, W = Work Week
$\mathrm{G}=\mathrm{Pb}-$ Free Package

ORDERING INFORMATION
See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.

MAXIMUM RATINGS (Voltages Referenced to $\mathrm{V}_{\mathrm{SS}}$ )

| Symbol | Parameter | Value | Unit |
| :---: | :--- | :---: | :---: |
| $\mathrm{V}_{\mathrm{DD}}$ | DC Supply Voltage Range | -0.5 to +18.0 | V |
| $\mathrm{~V}_{\text {in }}, \mathrm{V}_{\text {out }}$ | Input or Output Voltage Range <br> (DC or Transient) | -0.5 to $\mathrm{V}_{\mathrm{DD}}+0.5$ | V |
| $\mathrm{I}_{\text {in }}, \mathrm{I}_{\text {out }}$ | Input or Output Current <br> (DC or Transient) per Pin | $\pm 10$ | mA |
| $\mathrm{P}_{\mathrm{D}}$ | Power Dissipation, per Package (Note 1) | 500 | mW |
| $\mathrm{~T}_{\mathrm{A}}$ | Ambient Temperature Range | -55 to +125 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {stg }}$ | Storage Temperature Range | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{L}}$ | Lead Temperature <br> (8-Second Soldering) | 260 | ${ }^{\circ} \mathrm{C}$ |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Temperature Derating: "D/DW" Packages: $-7.0 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ From $65^{\circ} \mathrm{C}$ To $125^{\circ} \mathrm{C}$

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, $\mathrm{V}_{\text {in }}$ and $\mathrm{V}_{\text {out }}$ should be constrained to the range $\mathrm{V}_{S S} \leq\left(\mathrm{V}_{\text {in }}\right.$ or $\left.\mathrm{V}_{\text {out }}\right) \leq \mathrm{V}_{\mathrm{DD}}$.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either $\mathrm{V}_{S S}$ or $\mathrm{V}_{\mathrm{DD}}$ ). Unused outputs must be left open.

## PIN ASSIGNMENT

| OUTPUT \& A | $1 \bullet$ | 16 | $\mathrm{V}_{\mathrm{DD}}$ |
| :---: | :---: | :---: | :---: |
| DISABLE ${ }^{\text {B }}$ | 2 | 15 | R |
| Q0 | 3 | 14 | D0 |
| Q1 1 | 4 | 13 | D1 |
| Q2 | 5 | 12 | D2 |
| Q3 | 6 | 11 | D3 |
| C | 7 | 10 | 1 B DATA |
| $\mathrm{V}_{\text {SS }}$ [ | 8 | 9 | 7 A dISABLE |

## BLOCK DIAGRAM



FUNCTION TABLE

| Inputs |  |  |  |  | Output Q |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Reset | Clock | Data Disable |  | $\begin{gathered} \text { Data } \\ \text { D } \end{gathered}$ |  |
|  |  | A | B |  |  |
| 1 | X | X | X | X | 0 |
| 0 | 0 | X | X | X | $Q_{n}$ |
| 0 | - | 1 | X | X | $Q_{n}$ |
| 0 | J | X | 1 | X | $Q_{n}$ |
| 0 | $\checkmark$ | 0 | 0 | 0 | 0 |
| 0 | $\checkmark$ | 0 | 0 | 1 | 1 |

When either output disable A or B (or both) is (are) high the output is disabled to the high-impedance state; however sequential operation of the flip-flops is not affected.
X = Don't Care.

ELECTRICAL CHARACTERISTICS (Voltages Referenced to $\mathrm{V}_{\mathrm{SS}}$ )

| Characteristic | Symbol | VDDVdc | $-55^{\circ} \mathrm{C}$ |  | $25^{\circ} \mathrm{C}$ |  |  | $125^{\circ} \mathrm{C}$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max | Min | Typ (Note 2) | Max | Min | Max |  |
| Output Voltage <br> "0" Level $V_{\text {in }}=V_{D D} \text { or } 0$ <br> "1" Level $V_{\text {in }}=0 \text { or } V_{D D}$ | $\mathrm{V}_{\text {OL }}$ | $\begin{aligned} & \hline 5.0 \\ & 10 \\ & 15 \end{aligned}$ | - | $\begin{aligned} & 0.05 \\ & 0.05 \\ & 0.05 \end{aligned}$ | - | $\begin{aligned} & 0 \\ & 0 \\ & 0 \end{aligned}$ | $\begin{aligned} & 0.05 \\ & 0.05 \\ & 0.05 \end{aligned}$ | - | $\begin{aligned} & \hline 0.05 \\ & 0.05 \\ & 0.05 \end{aligned}$ | Vdc |
|  | $\mathrm{V}_{\mathrm{OH}}$ | $\begin{aligned} & \hline 5.0 \\ & 10 \\ & 15 \end{aligned}$ | $\begin{gathered} \hline 4.95 \\ 9.95 \\ 14.95 \end{gathered}$ | - | $\begin{gathered} 4.95 \\ 9.95 \\ 14.95 \end{gathered}$ | $\begin{aligned} & 5.0 \\ & 10 \\ & 15 \end{aligned}$ | - | $\begin{gathered} 4.95 \\ 9.95 \\ 14.95 \end{gathered}$ | - | Vdc |
|  | $\mathrm{V}_{\mathrm{IL}}$ | $\begin{aligned} & 5.0 \\ & 10 \\ & 15 \end{aligned}$ | - | $\begin{aligned} & 1.5 \\ & 3.0 \\ & 4.0 \end{aligned}$ | - | $\begin{aligned} & 2.25 \\ & 4.50 \\ & 6.75 \end{aligned}$ | $\begin{aligned} & 1.5 \\ & 3.0 \\ & 4.0 \end{aligned}$ | - | $\begin{aligned} & 1.5 \\ & 3.0 \\ & 4.0 \end{aligned}$ | Vdc |
|  | $\mathrm{V}_{\mathrm{IH}}$ | $\begin{aligned} & 5.0 \\ & 10 \\ & 15 \end{aligned}$ | $\begin{gathered} 3.5 \\ 7.0 \\ 11 \end{gathered}$ | - | $\begin{gathered} 3.5 \\ 7.0 \\ 11 \end{gathered}$ | $\begin{aligned} & 2.75 \\ & 5.50 \\ & 8.25 \end{aligned}$ | - | $\begin{gathered} 3.5 \\ 7.0 \\ 11 \end{gathered}$ | - | Vdc |
| Output Drive Current  <br> $\left(\mathrm{V}_{\mathrm{OH}}=2.5 \mathrm{Vdc}\right)$ Source <br> $\left(\mathrm{V}_{\mathrm{OH}}=4.6 \mathrm{Vdc}\right)$  <br> $\left(\mathrm{V}_{\mathrm{OH}}=9.5 \mathrm{Vdc}\right)$  <br> $\left(\mathrm{V}_{\mathrm{OH}}=13.5 \mathrm{Vdc}\right)$  | IOH | $\begin{aligned} & 5.0 \\ & 5.0 \\ & 10 \\ & 15 \end{aligned}$ | $\begin{gathered} -3.0 \\ -0.64 \\ -1.6 \\ -4.2 \end{gathered}$ | - - - | $\begin{aligned} & -2.4 \\ & -0.51 \\ & -1.3 \\ & -3.4 \end{aligned}$ | $\begin{gathered} -4.2 \\ -0.88 \\ -2.25 \\ -8.8 \end{gathered}$ | - | $\begin{gathered} -1.7 \\ -0.36 \\ -0.9 \\ -2.4 \end{gathered}$ | - | mAdc |
| $\begin{array}{ll} \left(\mathrm{V}_{\mathrm{OL}}=0.4 \mathrm{Vdc}\right) & \text { Sink } \\ \left(\mathrm{V}_{\mathrm{OL}}=0.5 \mathrm{Vdc}\right) & \\ \left(\mathrm{V}_{\mathrm{OL}}=1.5 \mathrm{Vdc}\right) & \end{array}$ | l OL | $\begin{aligned} & \hline 5.0 \\ & 10 \\ & 15 \end{aligned}$ | $\begin{gathered} \hline 0.64 \\ 1.6 \\ 4.2 \end{gathered}$ | - | $\begin{gathered} \hline 0.51 \\ 1.3 \\ 3.4 \end{gathered}$ | $\begin{gathered} 0.88 \\ 2.25 \\ 8.8 \end{gathered}$ | - | $\begin{gathered} 0.36 \\ 0.9 \\ 2.4 \end{gathered}$ | - | mAdc |
| Input Current | $1{ }_{\text {in }}$ | 15 | - | $\pm 0.1$ | - | $\pm 0.00001$ | $\pm 0.1$ | - | $\pm 1.0$ | $\mu \mathrm{Adc}$ |
| Input Capacitance $\left(\mathrm{V}_{\mathrm{in}}=0\right)$ | $\mathrm{C}_{\text {in }}$ | - | - | - | - | 5.0 | 7.5 | - | - | pF |
| Quiescent Current (Per Package) | IDD | $\begin{aligned} & 5.0 \\ & 10 \\ & 15 \end{aligned}$ | - | $\begin{aligned} & 5.0 \\ & 10 \\ & 20 \end{aligned}$ | - | $\begin{aligned} & \hline 0.005 \\ & 0.010 \\ & 0.015 \end{aligned}$ | $\begin{aligned} & 5.0 \\ & 10 \\ & 20 \end{aligned}$ | - | $\begin{aligned} & 150 \\ & 300 \\ & 600 \end{aligned}$ | $\mu \mathrm{Adc}$ |
| Total Supply Current (Notes 3, 4) (Dynamic plus Quiescent, Per Package) ( $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ on all outputs, all buffers switching) | ${ }_{\text {IT }}$ | $\begin{aligned} & \hline 5.0 \\ & 10 \\ & 15 \end{aligned}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{T}}=(0.75 \mu \mathrm{~A} / \mathrm{kHz}) \mathrm{f}+\mathrm{I}_{\mathrm{DD}} \\ & \mathrm{I}_{\mathrm{T}}=(1.50 \mu \mathrm{~A} / \mathrm{kHz}) \mathrm{f}+\mathrm{I}_{\mathrm{DD}} \\ & \mathrm{I}_{\mathrm{T}}=(2.25 \mu \mathrm{~A} / \mathrm{kHz}) \mathrm{f}+\mathrm{I}_{\mathrm{DD}} \end{aligned}$ |  |  |  |  |  |  | $\mu \mathrm{Adc}$ |
| Three-State Leakage Current | $\mathrm{I}_{\text {TL }}$ | 15 | - | $\pm 0.1$ | - | $\pm 0.0001$ | $\pm 0.1$ | - | $\pm 3.0$ | $\mu \mathrm{Adc}$ |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
2. Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.
3. The formulas given are for the typical characteristics only at $25^{\circ} \mathrm{C}$.
4. To calculate total supply current at loads other than 50 pF :

$$
I_{T}\left(C_{L}\right)=I_{T}(50 p F)+\left(C_{L}-50\right) \text { Vfk }
$$

where: $I_{T}$ is in $\mu \mathrm{A}$ (per package), $\mathrm{C}_{\mathrm{L}}$ in $\mathrm{pF}, \mathrm{V}=\left(\mathrm{V}_{\mathrm{DD}}-\mathrm{V}_{S S}\right)$ in volts, f in kHz is input frequency, and $\mathrm{k}=0.002$.

SWITCHING CHARACTERISTICS (Note 5) ( $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ )

| Characteristic | Symbol | $\begin{aligned} & \hline \mathrm{V}_{\mathrm{DD}} \\ & \mathrm{Vdc} \end{aligned}$ | Min | $\begin{gathered} \text { Typ } \\ \text { (Note 6) } \end{gathered}$ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Output Rise and Fall Time $\begin{aligned} & \mathrm{t}_{\mathrm{TLH}}, \mathrm{t}_{\mathrm{THL}}=(1.5 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}+25 \mathrm{~ns} \\ & \mathrm{t}_{\mathrm{TL}, \mathrm{H},} \mathrm{t}_{\mathrm{THL}}=(0.75 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}+12.5 \mathrm{~ns} \\ & \mathrm{t}_{\mathrm{TLH}}, \mathrm{t}_{\mathrm{THL}}=(0.55 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}+9.5 \mathrm{~ns} \end{aligned}$ | ${ }_{\text {t }}$ LH, $\mathrm{t}_{\text {THL }}$ | $\begin{aligned} & 5.0 \\ & 10 \\ & 15 \end{aligned}$ | - | $\begin{gathered} 100 \\ 50 \\ 40 \end{gathered}$ | $\begin{gathered} 200 \\ 100 \\ 80 \end{gathered}$ | ns |
| ```Propagation Delay Time Clock to Q \(t_{\text {PLH }}, \mathrm{t}_{\mathrm{PHL}}=(1.7 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}+215 \mathrm{~ns}\) \(t_{\text {PLH }}, t_{\text {PHL }}=(0.66 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}+92 \mathrm{~ns}\) \(\mathrm{t}_{\mathrm{PLH}}, \mathrm{t}_{\mathrm{PHL}}=(0.5 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}+65 \mathrm{~ns}\) Reset to Q \(t_{\text {PLH }}, \mathrm{t}_{\mathrm{PHL}}=(1.7 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}+215 \mathrm{~ns}\) \(t_{\text {PLL }}, t_{\text {PHL }}=(0.66 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}+92 \mathrm{~ns}\) \(t_{\text {PLH }}, \mathrm{t}_{\text {PHL }}=(0.5 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}+65 \mathrm{~ns}\)``` | $\mathrm{t}_{\text {PLH }}, \mathrm{t}_{\text {PHL }}$ | $\begin{aligned} & 5.0 \\ & 10 \\ & 15 \\ & \hline \\ & \hline 5.0 \\ & 10 \\ & 15 \end{aligned}$ |  | $\begin{gathered} 300 \\ 125 \\ 90 \\ \hline \\ 300 \\ 125 \\ 90 \end{gathered}$ | $\begin{array}{r} 600 \\ 250 \\ 180 \\ \hline \\ 600 \\ 250 \\ 180 \end{array}$ | ns |
| 3 -State Propagation Delay, Output "1" or "0" to High Impedance | $\mathrm{t}_{\text {PHZ }}, \mathrm{t}_{\text {PLZ }}$ | $\begin{aligned} & 5.0 \\ & 10 \\ & 15 \end{aligned}$ | - | $\begin{aligned} & \hline 150 \\ & 60 \\ & 45 \end{aligned}$ | $\begin{gathered} \hline 300 \\ 120 \\ 90 \end{gathered}$ | ns |
| 3-State Propagation Delay, High Impedance to " 1 " or "0" Level | $\mathrm{t}_{\text {PZH }}, \mathrm{t}_{\text {PZL }}$ | $\begin{aligned} & \hline 5.0 \\ & 10 \\ & 15 \end{aligned}$ | - | $\begin{gathered} 200 \\ 80 \\ 60 \end{gathered}$ | $\begin{aligned} & \hline 400 \\ & 160 \\ & 120 \end{aligned}$ | ns |
| Clock Pulse Width | ${ }^{\text {twh }}$ | $\begin{aligned} & 5.0 \\ & 10 \\ & 15 \end{aligned}$ | $\begin{gathered} \hline 260 \\ 110 \\ 80 \end{gathered}$ | $\begin{aligned} & \hline 130 \\ & 55 \\ & 40 \end{aligned}$ |  | ns |
| Reset Pulse Width | $t_{\text {wh }}$ | $\begin{aligned} & \hline 5.0 \\ & 10 \\ & 15 \end{aligned}$ | $\begin{aligned} & \hline 370 \\ & 150 \\ & 110 \end{aligned}$ | $\begin{aligned} & 185 \\ & 75 \\ & 55 \end{aligned}$ | $\begin{aligned} & \text { - } \\ & \text { - } \end{aligned}$ | ns |
| Data Setup Time | $\mathrm{t}_{\text {su }}$ | $\begin{aligned} & \hline 5.0 \\ & 10 \\ & 15 \end{aligned}$ | $\begin{gathered} 30 \\ 10 \\ 4 \end{gathered}$ | $\begin{gathered} \hline 15 \\ 5 \\ 2 \end{gathered}$ |  | ns |
| Data Hold Time | $t_{\text {h }}$ | $\begin{aligned} & 5.0 \\ & 10 \\ & 15 \end{aligned}$ | $\begin{gathered} \hline 130 \\ 60 \\ 50 \end{gathered}$ | $\begin{aligned} & \hline 65 \\ & 30 \\ & 25 \end{aligned}$ | $\begin{aligned} & \text { - } \\ & \text { - } \end{aligned}$ | ns |
| Data Disable Setup Time | $\mathrm{t}_{\text {su }}$ | $\begin{aligned} & \hline 5.0 \\ & 10 \\ & 15 \end{aligned}$ | $\begin{gathered} \hline 220 \\ 80 \\ 50 \end{gathered}$ | $\begin{aligned} & 110 \\ & 40 \\ & 25 \end{aligned}$ | $\begin{aligned} & \text { - } \\ & \text { - } \end{aligned}$ | ns |
| Clock Pulse Rise and Fall Time | ${ }_{\text {t }}$ LH, $\mathrm{t}_{\text {THL }}$ | $\begin{aligned} & \hline 5.0 \\ & 10 \\ & 15 \end{aligned}$ | - | - | $\begin{gathered} \hline 15 \\ 5 \\ 4 \end{gathered}$ | us |
| Clock Pulse Frequency | $\mathrm{f}_{\mathrm{Cl}}$ | $\begin{aligned} & \hline 5.0 \\ & 10 \\ & 15 \end{aligned}$ | - | $\begin{aligned} & 3.6 \\ & 9.0 \\ & 12 \end{aligned}$ | $\begin{aligned} & \hline 1.8 \\ & 4.5 \\ & 6.0 \end{aligned}$ | MHz |

5. The formulas given are for the typical characteristics only at $25^{\circ} \mathrm{C}$.
6. Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.


Figure 1. Timing Diagram


Figure 2. Three-State Propagation Delay Waveshape and Circuit

EQUIVALENT
FUNCTIONAL BLOCK DIAGRAM


ORDERING INFORMATION

| Device | Package | Shipping $^{\dagger}$ |
| :--- | :---: | :---: |
| MC14076BDG | SOIC-16 <br> (Pb-Free) | 48 Units / Rail |
| MC14076BDR2G | SOIC-16 <br> (Pb-Free) | 2500 Units / Tape \& Reel |
| NLV14076BDR2G* | SOIC-16 <br> (Pb-Free) | 2500 Units / Tape \& Reel |

$\dagger$ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
*NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

## MC14076B

## PACKAGE DIMENSIONS



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 ( 0.006 ) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION

|  | MILLIMETERS |  | INCHES |  |
| :---: | ---: | ---: | ---: | ---: |
| DIM | MIN | MAX | MIN | MAX |
| A | 9.80 | 10.00 | 0.386 | 0.393 |
| B | 3.80 | 4.00 | 0.150 | 0.157 |
| C | 1.35 | 1.75 | 0.054 | 0.068 |
| D | 0.35 | 0.49 | 0.014 | 0.019 |
| F | 0.40 | 1.25 | 0.016 | 0.049 |
| G | 1.27 | BSC | 0.050 |  |
| BSC |  |  |  |  |
| J | 0.19 | 0.25 | 0.008 | 0.009 |
| K | 0.10 | 0.25 | 0.004 | 0.009 |
| M | $0^{\circ}$ | $7^{\circ}$ | $0^{\circ}$ | $7^{\circ}$ |
| P | 5.80 | 6.20 | 0.229 | 0.244 |
| R | 0.25 | 0.50 | 0.010 | 0.019 |

SOLDERING FOOTPRINT*


DIMENSIONS: MILLIMETERS
*For additional information on our $\mathrm{Pb}-$ Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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